

SURFACE MOUNT CHIP LED LAMPS

DATA SHEET

MODEL NO: GT5630-8W1AHT

REV. : 1.0

DATE : 01-Apr.-2009

Features

- . P-LCC-2 package.
- . White package.
- . Optical indicator.
- . Colorless clear window.
- . Pb-free.
- . Wide viewing angle.
- . Computable with automatic placement equipment.
- . Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- . The product itself will remain within RoHS compliant version



Descriptions

The GT5630 series is available in soft orange, green, blue, and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

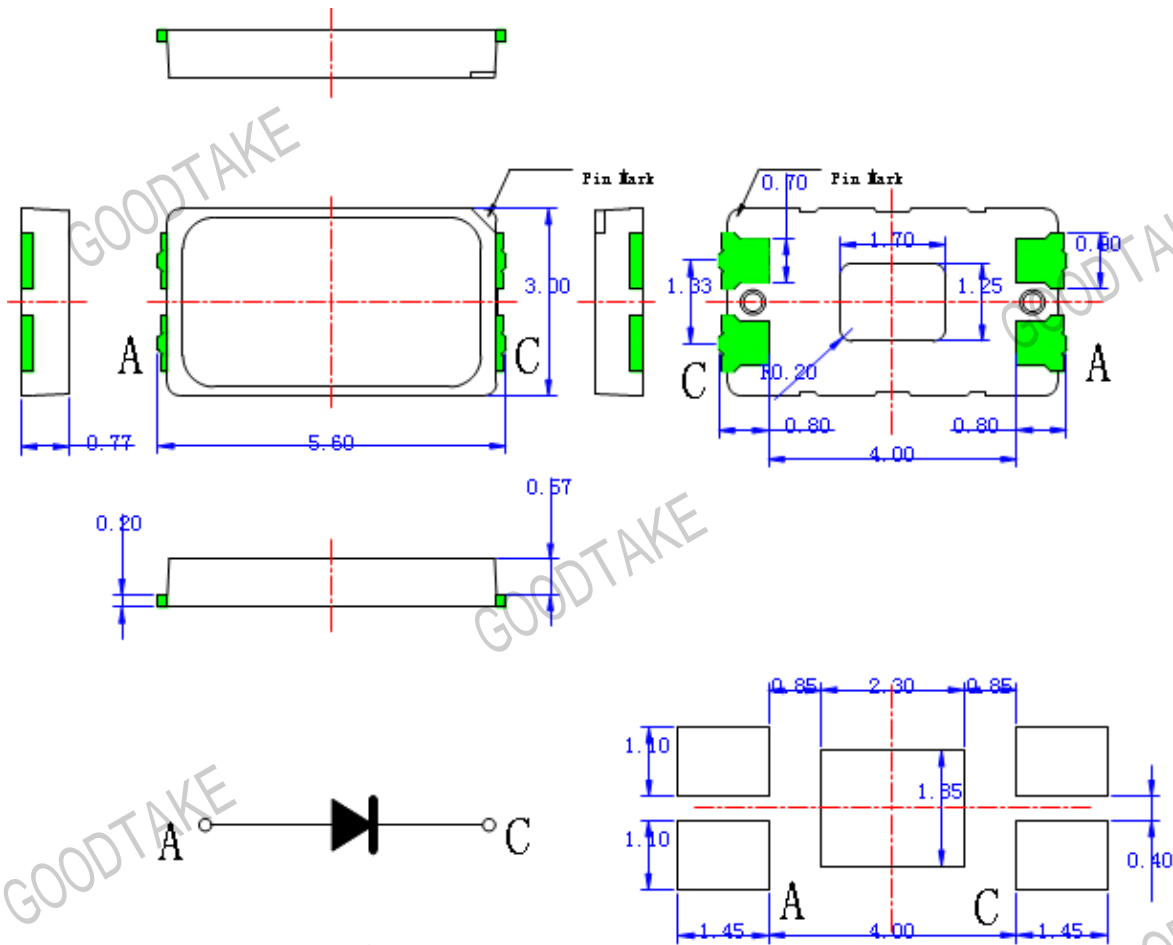
Applications

- . Optical indicator
- . indicator and backlighting in telephone and fax.
- . Flat backlight for LCD, switch and symbol.
- . Light pipe application.
- . General use.

Device Selection Guide

Material	Resin (mold)	Resin Color	Emitted Color
InGaN	Epoxy	Yellow Diffused	White

Package Dimension



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Absolute Maximum Rating ($T_a=25^\circ\text{C}$)

Item	Symbol	Condition	Absolute Maximum Rating	Unit
Forward Current	I_F		120	mA
Power Dissipation	P_D		460	mW
Operating Temperature	T_{opr}		-40~+85	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55~+100	$^\circ\text{C}$
Electrostatic Discharge	ESD		2000 (HBM)	V

Electrical and Optical Characteristics at (Ta=25°C)

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	I _F =120mA	2.8	--	3.6	V
50%Power angle	2θ _{1/2}		--	120	--	Deg
Luminous Flux	Φ _v		10000	--	18000	Mcd
Chromaticity Coordinates	CIE-X		0.3481	--	0.4187	--
	CIE-Y	0.3638	--	0.4300	--	
Reverse Voltage	V _R	I _R =5mA		0.9	1.2	V

Luminous Flux (lm at 120mA)

Rank	Min (mcd)	Max (mcd)
Q1	10000	12000
Q2	12000	15000
Q3	15000	18000

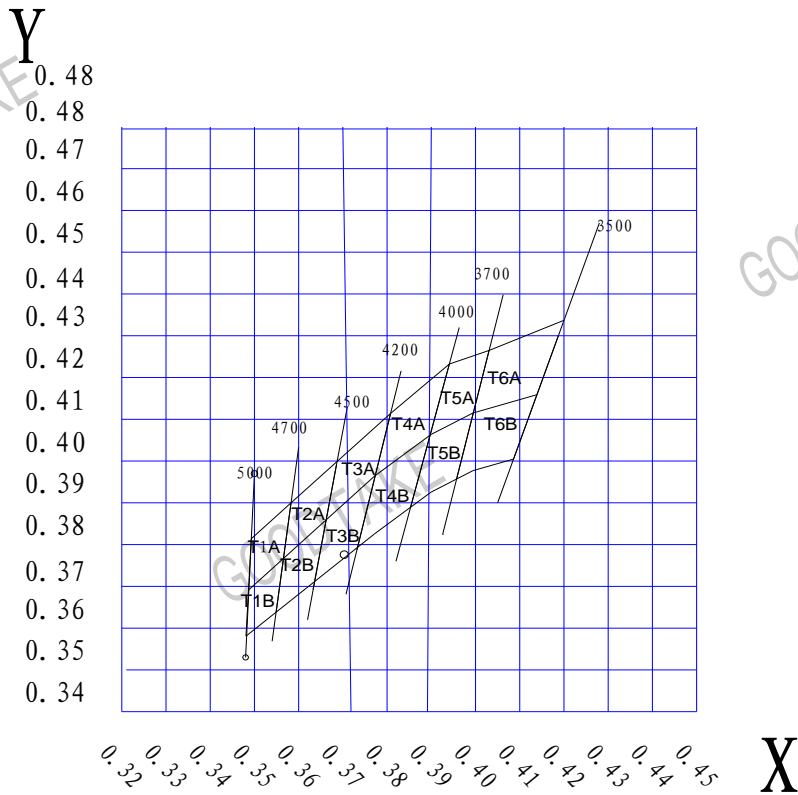
*Measurement Uncertainty of Luminous Intensity: ±10%.

Forward Voltage Combination (V at 120mA)

Rank T	0	1	2	3
Forward Voltage	2.8~2.9	2.9~3.0	3.0~3.1	3.1~3.2
Rank R	0	1	2	3
Forward Voltage	3.2~3.3	3.3~3.4	3.4~3.5	3.5~3.6

*Measurement Uncertainty of Forward Voltage: ±0.1V.

Color Combination (IF= 120mA)

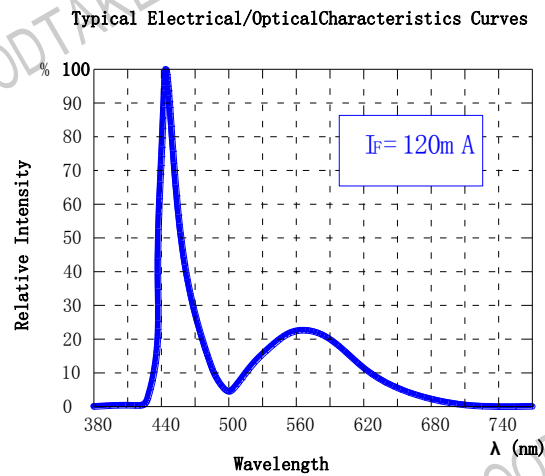
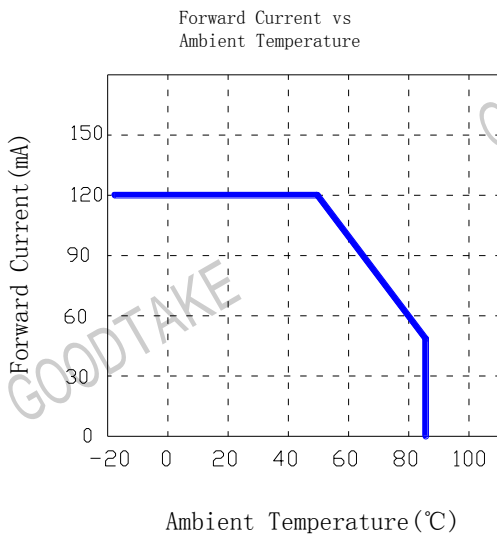
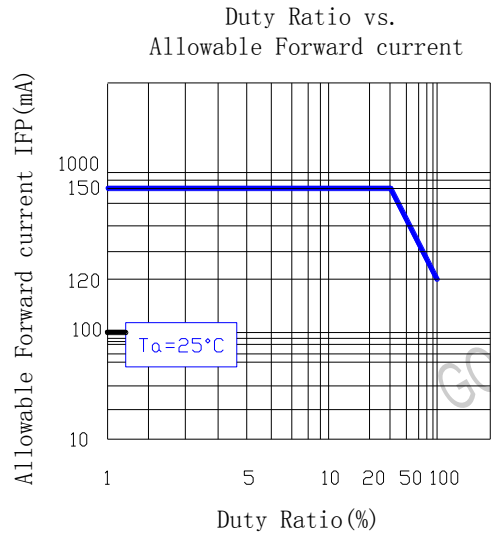
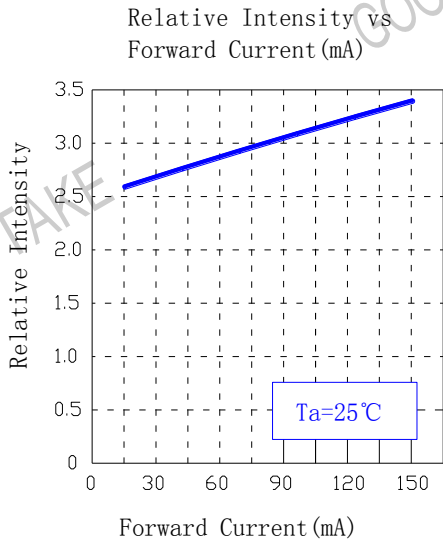
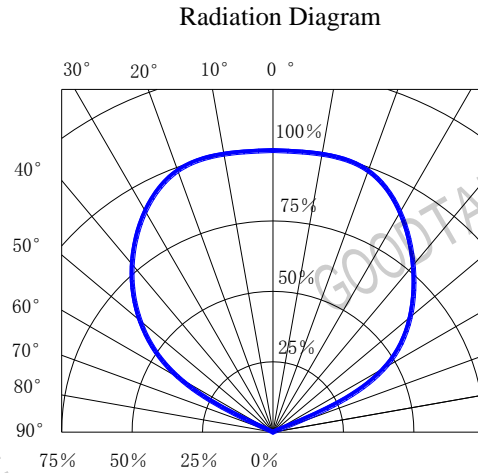
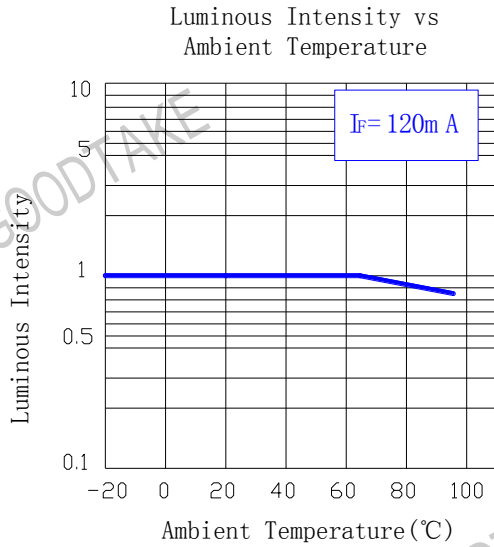


Color Ranks(IF=120mA, Ta=25°C)

Color Ranks		CIE				CCT
T1	X	0.3481	0.3493	0.3583	0.3549	4700-5000K
	Y	0.3581	0.3814	0.3900	0.3638	
T2	X	0.3549	0.3583	0.3687	0.3636	4500-4700K
	Y	0.3638	0.3900	0.3999	0.3712	
T3	X	0.3636	0.3687	0.3808	0.3735	4200-4500K
	Y	0.3712	0.3999	0.4114	0.3800	
T4	X	0.3735	0.3808	0.3941	0.3853	4000-4200K
	Y	0.3800	0.4114	0.4232	0.3889	
T5	X	0.3853	0.3941	0.4031	0.3957	3700-4000K
	Y	0.3889	0.4232	0.4265	0.3957	
T6	X	0.3957	0.4031	0.4187	0.4086	3500-3700K
	Y	0.3957	0.4265	0.4300	0.4005	

Measurement uncertainty of the color coordinates ± 0.003

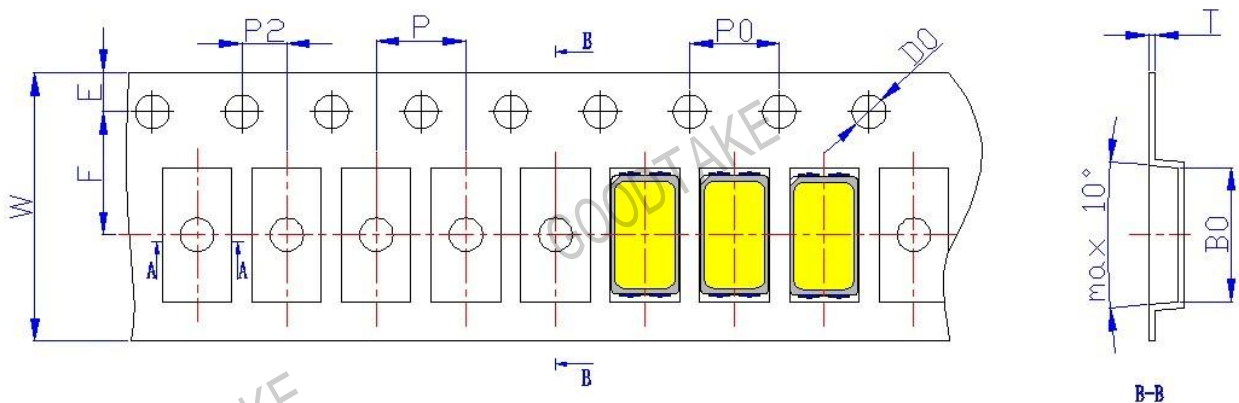
Typical Electrical / Optical Characteristics Curves (25°C Ambient Temperature Unless Otherwise Noted)



Test items and results of reliability

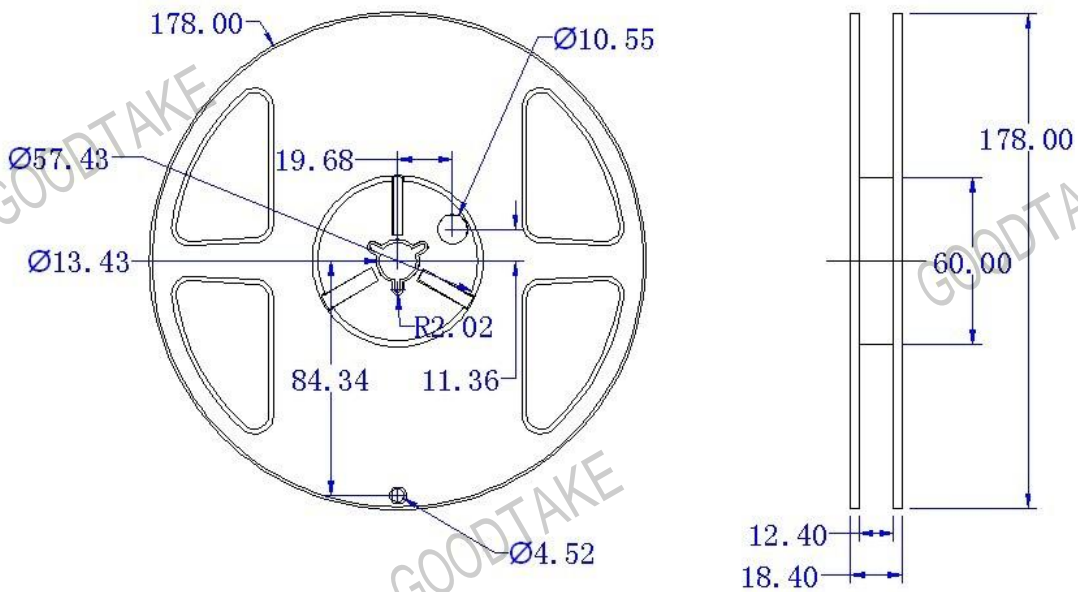
NO	Item	Test Conditions	Test Hours/Cycle	Sample Size	Ac/Re
1	Reflow	TEMP: 260±5°C Min. 5sec.	6 MIN.	22 PCS	0/1
2	Temperature Cycle	H: +100°C 15min ↓ 5 min L: -40°C 15min	300 CYCLES	22 PCS	0/1
3	Thermal Shock	H: +100°C 5min ↓ 10 sec L: -10°C 5min	300 CYCLES	22 PCS	0/1
4	High Temperature Storage	TEMP: 100°C	1000 HRS	22 PCS	0/1
5	Low Temperature Storage	TEMP: -55°C	1000 HRS	22 PCS	0/1
6	DC Operating Life	I _F = 120 mA / 25°C	1000 HRS	22 PCS	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 HRS	22 PCS	0/1

Package Dimensions of Tape



W	12±0.3	P	4±0.1	A0	3.20±0.1
F	5.5±0.1	P0	4±0.1	B0	5.80±0.1
T	0.3±0.05	P2	2±0.1	K0	1.00±0.1
D0	1.50 ^{+0.1} ₀	E	1.75±0.1		

Package Dimensions of Reel



Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-2000 pieces per reel.
3. Minimum packing quantity is 500 pieces for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with EIA-481-1-B specifications.

Soldering Condition

1. Pb-free solder temperature profile
2. Reflow soldering should not be done more than two times.
3. When soldering, do not put stress on the LEDs during heating.
4. After soldering, do not warp the circuit board.

Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.